









Release Date: 21 May 2020 Version: A1.0

# PRODUCT DATASHEET



- ► EMC 2-PIN SMD
- ➤ 3030 0.52t Series
- ► Red (625nm)

NOR51S44



# **3030 0.52t Series**





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#### **APPLICATIONS:**

- **Decorative Lighting**
- Portable Lighting
- **Outdoor Lighting**
- Commercial Lighting
- **Architectural Lighting**

# **FEATURES:**

Package: TOP View EMC White SMT Package

Forward Current: 350mA Forward Voltage (typ.): 2.2V

Luminous Flux (typ.): 44lm@350mA

Colour: Red

Wavelength: 615~630nm

Viewing angle: 120°

**Materials:** 

Die: AlGaInP

Resin: Silicon (Water Clear)

L/T Finish: Ag plated

Operating Temperature: -40~+105°C

**Storage Temperature:** -40~+85°C

**Grouping parameters:** 

Forward Voltage

Luminous Flux

**Dominant Wavelength** 

Soldering methods: Reflow

Preconditioning: MSL3 according to J-STD020

Packing: 8mm tape with max.5000/reel, ø165mm (6.5")



#### **CHARACTERISTICS:**

# Absolute Maximum Characteristics (Ta=25°C)

| Parameter                                      | Symbol                | Ratings  | Unit |
|--|-----------------------|----------|------|
| DC Forward Current                             | IF                    | 400      | mA   |
| Pulse Forward Current (width≤100μS; duty≤1/10) | IFP                   | 600      | mA   |
| Power Dissipation                              | P <sub>D</sub>        | 1040     | mW   |
| Reverse Voltage                                | VR                    | 5        | V    |
| Reverse Current @5V                            | I <sub>R</sub>        | 10       | μΑ   |
| Thermal Resistance (Junction to Solder Point)  | R <sub>th(j-sp)</sub> | 10       | °C/W |
| Junction Temperature                           | Tj                    | 110      | °C   |
| Electrostatic Discharge (HBM: MIL-STD-883 C 2) | ESD                   | 1000     | V    |
| Operating Temperature                          | T <sub>OPR</sub>      | -40~+105 | °C   |
| Storage Temperature                            | T <sub>STG</sub>      | -40~+85  | °C   |

### Electrical & Optical Characteristics (Ta=25°C)

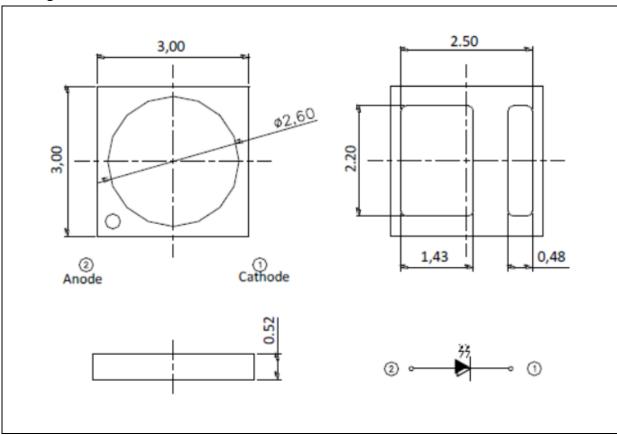
| Darameter           | Symbol            | Values |      |      | Lloit | Test                  |
|---------------------|-------------------|--------|------|------|-------|-----------------------|
| Parameter           | Зуппоп            | Min.   | Тур. | Max. | Unit  | Condition             |
| Forward Voltage     | $V_{F}$           | 1.8    | 2.2  | 2.6  | V     | I <sub>F</sub> =350mA |
| Luminous Flux       | Ф۷                | 37     | 44   | 58   | lm    | I <sub>F</sub> =350mA |
| Dominant Wavelength | $\lambda_{D}$     | 615    |      | 630  | nm    | I <sub>F</sub> =350mA |
| Viewing Angle       | 2θ <sub>1/2</sub> |        | 120  |      | deg   | I <sub>F</sub> =350mA |

<sup>1.</sup> Luminous flux ( $\Phi_V$ ) ±7%, Forward Voltage ( $V_F$ ) ±0.1V



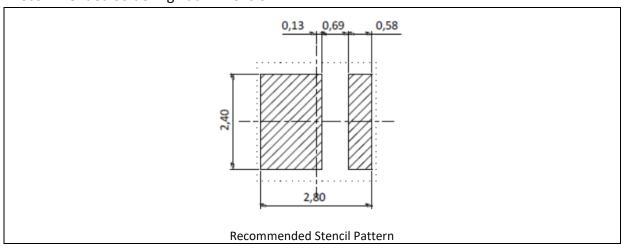
#### **OUTLINE DIMENSION:**

#### Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.13mm, unless otherwise noted.

#### Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm with angle tolerance ±0.5°.



#### **BINNING GROUPS:**

# Forward Voltage Classifications (I<sub>F</sub> = 350mA):

| Code | Min. | Max. | Unit |
|------|------|------|------|
| C3   | 1.8  | 2.0  |      |
| D3   | 2.0  | 2.2  | V    |
| E3   | 2.2  | 2.4  | V    |
| F3   | 2.4  | 2.6  |      |

#### Luminous Flux Classifications (I<sub>F</sub> = 350mA):

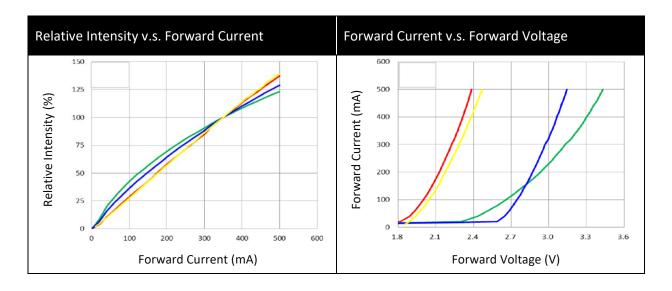
| Code | Min. | Max. | Unit |
|------|------|------|------|
| AM   | 37   | 44   |      |
| AN   | 44   | 51   | lm   |
| AP   | 51   | 58   |      |

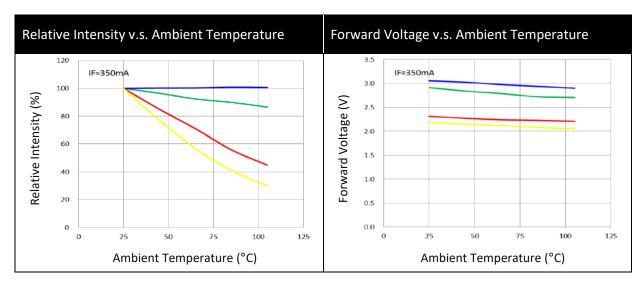
# Dominant Wavelength Classifications (I<sub>F</sub> = 350mA):

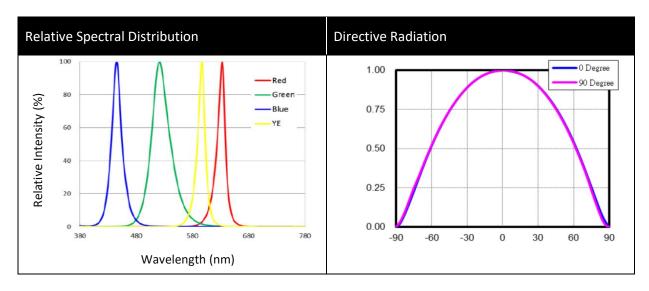
| Code | Min. | Max. | Unit |
|------|------|------|------|
| R615 | 615  | 520  |      |
| R620 | 520  | 525  | nm   |
| R625 | 525  | 530  |      |



#### **ELECTRO-OPTICAL CHARACTERISTICS:**

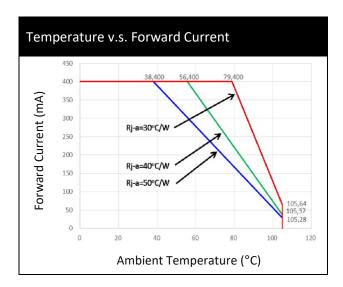








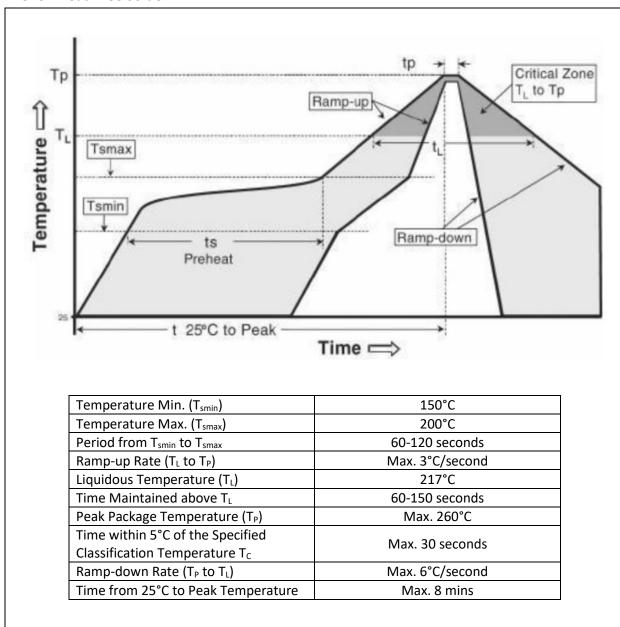
### **ELECTRO-OPTICAL CHARACTERISTICS:**





#### **RECOMMENDED SOLDERING PROFILE:**

#### Reflow Lead-free Solder:



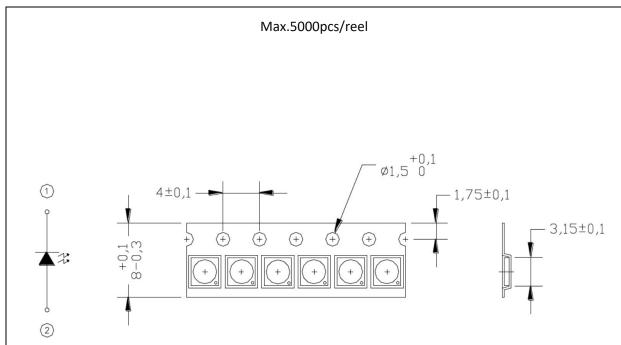
#### Note:

- 1. Maximum reflow soldering: 1 time.
- 2. Before, during, and after soldering, should not apply stress on the components and PCB board.
- 3. Recommended soldering temperature: 230°C. The maximum soldering temperature should be limited to 260°C for max. 10seconds.

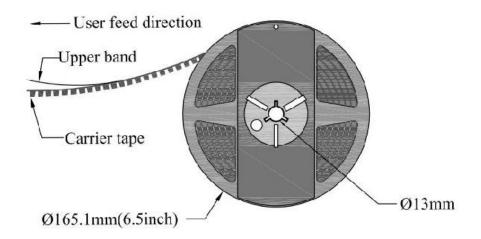


#### **PACKING SPECIFICATION:**

#### Reel Dimension:



- 1. Cumulative Tolerance : Cumulative Tolerance/10 pitches to be ±0.2mm
- 2. Adhesion Strength of Cover Tape Adhesion strength to be 0.1-0.7N when the cover tape is turned off from the carrier tape at the angle of 10° to the carrier tape.





#### **PRECAUTIONS OF USE:**

#### Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent <10% R.H. and apply baking before use.

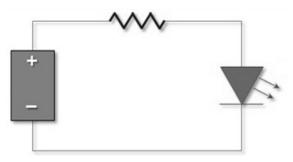
#### Baking:

It is required to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 60±5°C x 24hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

#### **Testing Circuit:**



Must apply resistor(s) for protection (over current proof).

#### Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

#### ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



# **REVISION RECORD:**

| Version | Date       | Summary of Revision |
|---------|------------|---------------------|
| A1.0    | 21/05/2020 | Datasheet set-up.   |